

#### **Product Summary**

Device	BVDSS	RDS(ON) Max	I <sub>D</sub> T <sub>A</sub> = +25°C
Q1 & Q4	160mΩ @ V <sub>GS</sub> = 1		2.9A
Q1 & Q4	100V	200mΩ @ V <sub>GS</sub> = 4.5V	2.6A
Q2 & Q3	1001/	250mΩ @ V <sub>GS</sub> = -10V	-2.3A
Q2 & Q3	-100V	300mΩ @ V <sub>GS</sub> = -4.5V	-2.1A

#### **Description and Applications**

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

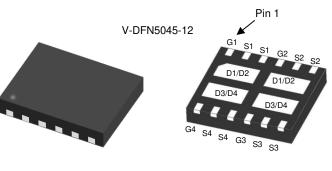
• High-efficiency bridge rectifiers

#### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/guality/product-definitions/</u>

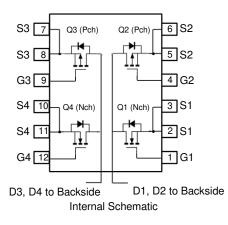
#### Mechanical Data

- Package: V-DFN5045-12
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @
- Weight: 0.056 grams (Approximate)



Top View

Bottom View



#### Ordering Information (Note 4)

Part Number	Paakaga	Tape Width	Packing		
Fait Number	Package	Tape width	Qty.	Carrier	
DMHC10H170SFJ-13	V-DFN5045-12	12mm	3,000	Tape & Reel	

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**

Notes:



) | | = Manufacturer's Marking
C170SJ = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 23 = 2023)
WW = Week Code (01 to 53)



## Maximum Ratings Q1 & Q4 N-Channel (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	100	V		
Gate-Source Voltage	Vgss	±20	V		
Continuous Drain Current (Note 5) $V_{GS}$ = 10V	Steady State	TA = +25°C TA = +70°C	lD	2.9 2.3	А
Maximum Body Diode Forward Current (Note 5)	ls	2.5	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	13	A		

## Maximum Ratings Q2 & Q3 P-Channel (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	-100	V		
Gate-Source Voltage	Vgss	±20	V		
Continuous Drain Current (Note 5) $V_{GS} = -10V$	Steady State	TA = +25°C TA = +70°C	lD	-2.3 -1.9	A
Maximum Body Diode Forward Current (Note 5)	ls	-2.3	A		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	ldм	-11	A		

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	2.1	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja 60 scom		°C/W
Thermal Resistance, Junction to Case (Note 5)	Rejc	6	-C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Note: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.



# Electrical Characteristics Q1 & Q4 N-Channel (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)	Symbol		тур	Max	Unit	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	100	_		V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	IDSS		_	1	μA	$V_{DS} = 80V, V_{GS} = 0V$
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)	1033			100	10.4	VG3 = ±200, VD3 = 00
Gate Threshold Voltage	VGS(TH)	1.0	2.0	3.0	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$
		_	111	160		$V_{GS} = 10V, I_D = 5A$
Static Drain-Source On-Resistance	RDS(ON)		121	200	mΩ	$V_{GS} = 4.5V, I_D = 5A$
Diode Forward Voltage	Vsd	_	0.9	1.0	V	VGs = 0V, Is = 10A
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	Ciss	_	1,167			
Output Capacitance	Coss	_	36	_	pF	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$
Reverse Transfer Capacitance	Crss	_	25			
Gate Resistance	Rg	_	1.3		Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1.0MHz
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	4.9			
Total Gate Charge (VGS = 10V)	Qg	_	9.7	_	-0	V 00V/ 10.0A
Gate-Source Charge	Qgs	_	2.0	_	nC	$V_{DS} = 80V, I_{D} = 12.8A$
Gate-Drain Charge	Qgd	_	2.0			
Turn-On Delay Time	td(on)	_	10.5	_		
Turn-On Rise Time	t <sub>R</sub>	_	11.1			
Turn-Off Delay Time	tD(OFF)	_	42.6		ns	$V_{DD} = 50V, R_G = 25\Omega, I_D = 12.8A$
Turn-Off Fall Time	tF	_	12.8			
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	30.3		ns	V <sub>GS</sub> = 0V, I <sub>S</sub> = 12.8A, dl/dt = 100A/µs
Body Diode Reverse Recovery Charge	QRR		35.2		nC	V <sub>GS</sub> = 0V, I <sub>S</sub> = 12.8A, dl/dt = 100A/µs

## Electrical Characteristics Q2 & Q3 P-Channel (@TA = +25°C, unless otherwise specified.)

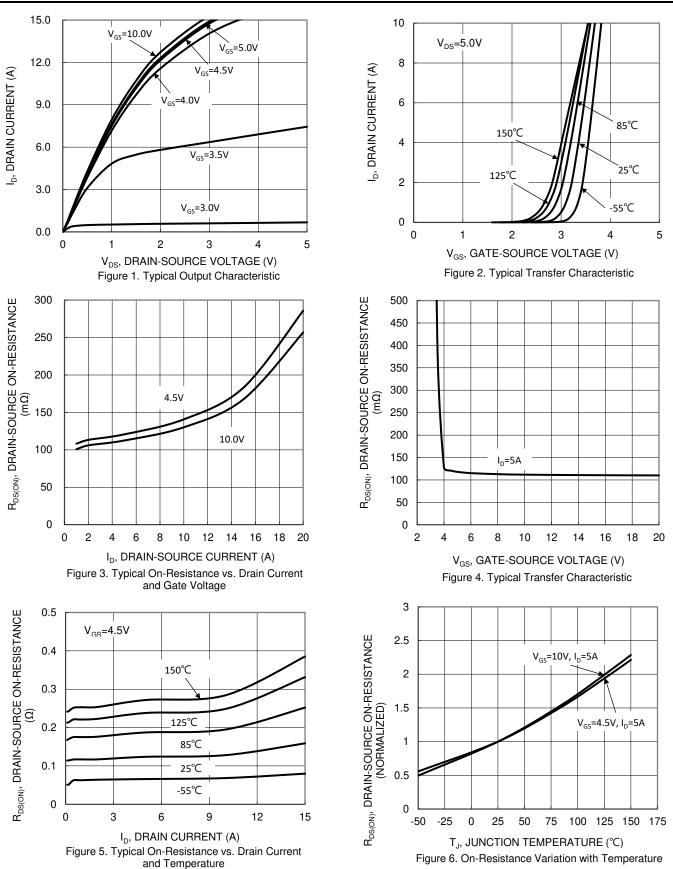
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)					-	
Drain-Source Breakdown Voltage	BVDSS	-100	_		V	$V_{GS} = 0V, I_D = -250 \mu A$
Zero Gate Voltage Drain Current	IDSS	—	_	1	μA	$V_{DS} = -80V, V_{GS} = 0V$
Gate-Source Leakage	lgss	—	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	VGS(TH)	-1.0	-1.6	-3.0	V	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$
Static Drain-Source On-Besistance	Deserve	_	191	250	mΩ	$V_{GS} = -10V, I_D = -5A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	213	300	11122	V <sub>GS</sub> = -4.5V, I <sub>D</sub> =-5A
Diode Forward Voltage	Vsd	_	-0.9	-1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -5A
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	Ciss	—	1,239	_		
Output Capacitance	Coss	_	42	_	pF	$V_{DS} = -25V, V_{GS} = 0V, f = 1.0MHz$
Reverse Transfer Capacitance	Crss	—	28	_		
Gate Resistance	Rg	_	13	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	_	8.4	_		
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg	_	17.5	_	nC	Vps = -60V. lp = -5A
Gate-Source Charge	Q <sub>gs</sub>	_	2.8	_	no	$v_{DS} = -60 v$ , $I_D = -5A$
Gate-Drain Charge	Qgd	_	3.2	_		
Turn-On Delay Time	td(ON)	_	9.1	_		
Turn-On Rise Time	tR	_	14.9	_		
Turn-Off Delay Time	tD(OFF)		57.4		ns	$V_{DD} = -50V, R_g = 9.1\Omega, I_D = -5A$
Turn-Off Fall Time	tF		34.4		1	
Body Diode Reverse Recovery Time	trr		25.2		ns	V <sub>GS</sub> = 0V, I <sub>S</sub> = -5A, dI/dt = 100A/µs
Body Diode Reverse Recovery Charge	QRR	_	24.5	_	nC	V <sub>GS</sub> = 0V, I <sub>S</sub> = -5A, dI/dt = 100A/µs

 Notes:
 6. Short duration pulse test used to minimize self-heating effect.

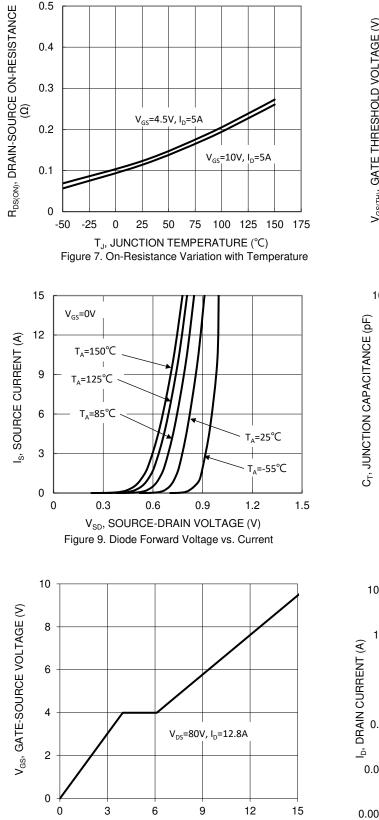
 7. Guaranteed by design. Not subject to production testing.



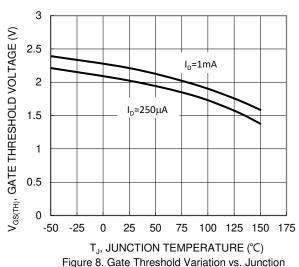
## **Typical Characteristics – N-CHANNEL**



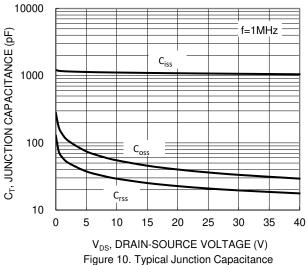


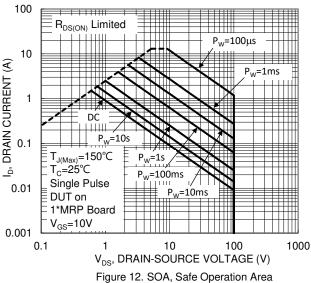


Q<sub>g</sub>, TOTAL GATE CHARGE (nC) Figure 11. Gate Charge



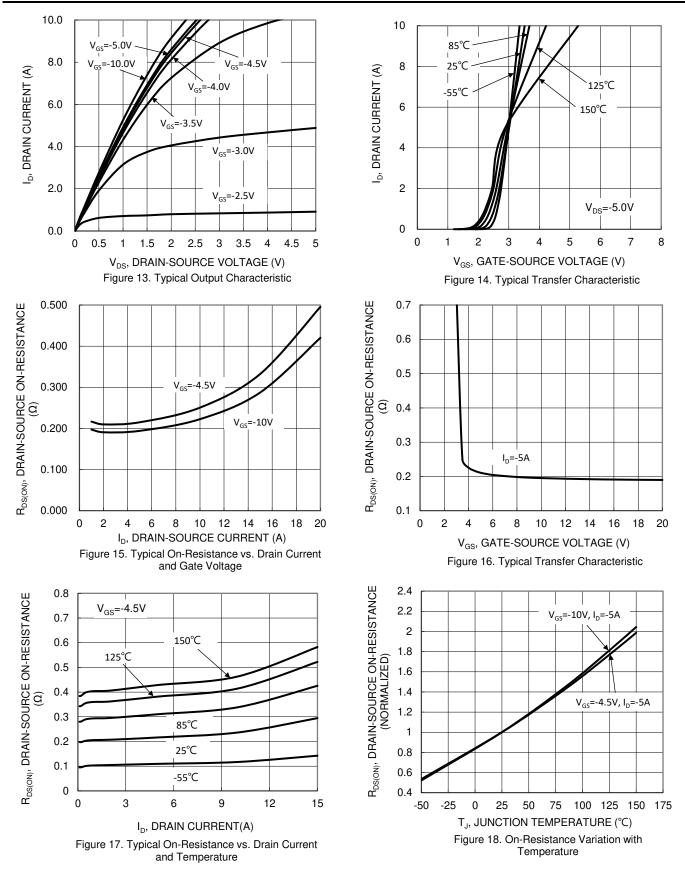
Temperature



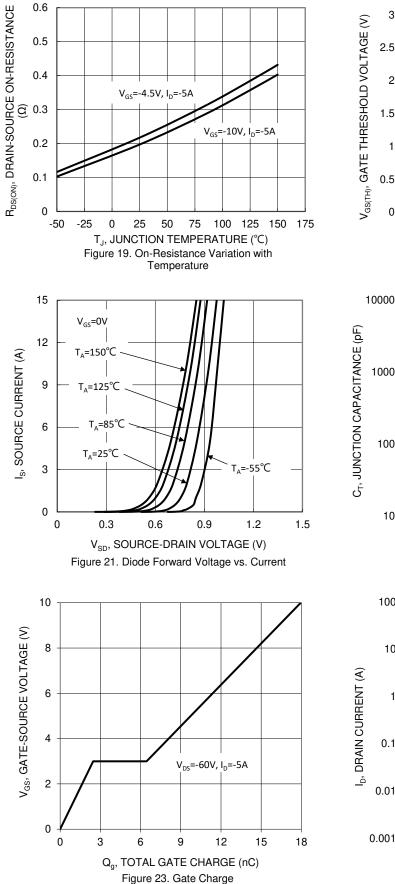


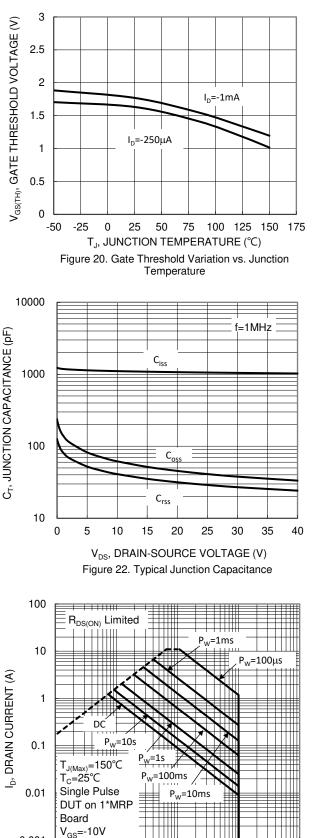


## **Typical Characteristics – P-CHANNEL**





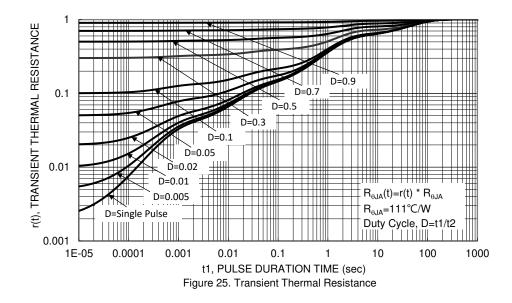




<sup>1 10 100 1000</sup> V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 24. SOA, Safe Operation Area

0.1



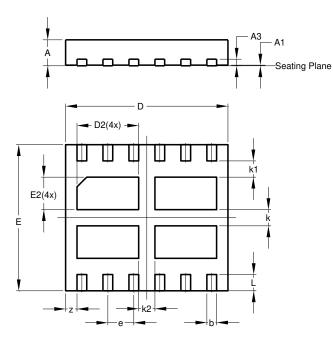




#### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

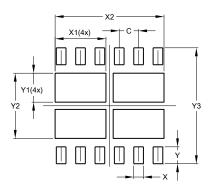
#### V-DFN5045-12



	V-DFN5	045-12	
Dim	Min	Max	Тур
Α	0.75	0.85	0.80
A1	0.00	0.05	0.02
A3	-	-	0.203
b	0.25	0.35	0.30
D	4.95	5.05	5.00
D2	1.80	2.00	1.90
ш	4.45	4.55	4.50
E2	0.90	1.10	1.00
е	-	-	0.80
k	-	-	0.50
k1	-	-	0.50
k2	-	-	0.50
L	0.45	0.55	0.50
z	-	-	0.35
All	Dimens	ions in m	າຫ

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



#### V-DFN5045-12

Dimensions	Value (in mm)
С	0.800
Х	0.400
X1	2.100
X2	4.500
Y	0.700
Y1	1.200
Y2	2.700
Y3	4.800



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